Rocktech Displays Limited

LCD Module Specification

Module P/N: RK024FH224A-T

Version: 1.0

Description : 2.4 inch TFT 240*320 Pixels
With LED backlight

TEL: 0086-755-26065260

Fax: 0086-755-26065261

E-mail: Sales@rocktech.com.hk

Web: www.rocktech.com.hk

Revision History

Date	Rev.	Page	Description
01/06/2013	1.0	All	First issue

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1. General Features

Item	Spec	Remark
Display Mode	Normally White transmissive	
Viewing Direction	6 O'CLOCK	
Input Signals	CPU 8/16 bit	
Outline Dimensions	42.72(W) x60.3(H) x3.45(D) Max.	With TP
Active Area	36.72mm(W)×48.96mm(H)	
Number of Pixels	240×RGB×320 Pixels	
Dot Pitch	0.153mm(H)×0.153mm(W)	
Pixel Arrangement	RGB Vertical stripes	
Drive IC	ILI9341	

2. Absolute Maximum Ratings

The following are maximum values which, if exceeded may cause operation or damage to the unit.

ITEM	Sym.	Min.	Typ.	Max.	Unit	Remark
Power for Circuit Driving	Vcc	-0.3	-	4.6	V	
Power for Circuit Logic	Vt	-0.3	-	Vcc+0.3	V	
Storage Humidity	H_{ST}	10	-		%RH	At 25±5℃
Storage Temperature	T_{ST}	-30	-	70	℃	
Operating Humidity	H_{OP}	10	-		%RH	
Operating temperature	T_{OP}	-20	-	60	℃	

3. Electrical Specification

3.1 Driving TFT LCD Panel

Item		Sym.	Min	Typ.	Max	Unit	Note
Power for Circuit Driving		VCC	2.5	2.8	3.3	V	
Power for Circuit Logic		IOVCC	1.65	1.8	3.3	V	
Logic Input Voltage	Low Voltage	V_{IL}	-0.3	-	0.2Vcc	V	
	High Voltage	V_{IH}	0.8Vcc	-	Vcc	V	
Logic Output Voltage	Low Voltage	V_{OL}	0	-	0.2Vcc	V	
	High Voltage	V_{OH}	0.8Vcc	-	-	V	
Power Consumption	Black Mode	P_b	T.B.D	T.B.D	T.B.D	mW	
	Standby Mode	P_w	T.B.D	T.B.D	T.B.D	mW	

3.2 Driving Backlight

Item	Sym.	Min	Typ.	Max	Unit	Note
Backlight driving voltage	V_F	3.0	3.2	3.4	V	
Backlight driving current	I_F	60	60	80	mA	
Backlight Power Consumption	W_{BL}	-	192	-	mW	
Life Time	-	-	20,000	-		Note 3

Note 1: (Unless specified, the ambient temperature Ta=25℃)
Note 2: The recommended operating conditions refer to a range in which operation of this product is guaranteed. Should this range is exceeded, the operation cannot be guaranteed even if the values may be without the absolute maximum ratings.
Note 3: If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.

4.Optical Specifications

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25 ℃. The values specified are at an approximate distance 500mm from the LCD surface at a viewing angle of Φ and θ equal to 0°.

Item	Sym.	Values			Unit	Note
		Min.	Typ.	Max.		
1)Contrast Ratio	C/R	350	500	-		FIG.1
2)Module Luminance	L	-	200	-	cd/m^2	With TP
3)Response time	Tr+Tf	-	25	40	ms	FIG.2
4)Viewing Angle	θ_T	40	50	-	Degree	FIG.3
	θ_B	50	60	-		
	θ_L	50	60	-		
	θ_R	50	60	-		
5)Chromaticity	Wx	0.284	0.299	0.314		
	Wy	0.318	0.333	0.348		
	Rx	-	-	-		
	Ry	-	-	-		
	Gx	-	-	-		
	Gy	-	-	-		
	Bx	-	-	-		
	By	-	-	-		

◆ Measurement System

Notes:

1. Contrast Ratio(CR) is defined mathematically as :

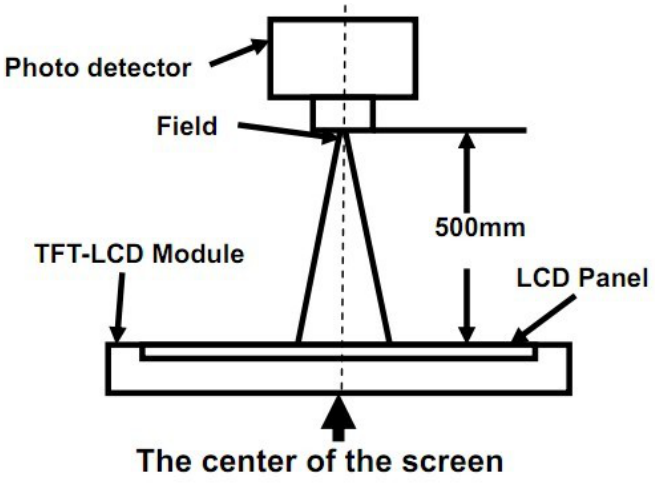
$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

2. Surface luminance is the center point across the LCD surface 500mm from the surface with all pixels displaying white. For more information see FIG 1.

3. Response time is the time required for the display to transition from white to black (Rising Time, Tr) and from black to white (Falling Time, Tf). For additional information see FIG 2.

4. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

FIG. 1 Optical Characteristic Measurement Equipment and Method



Item	Photo detector	Field
Contrast Ratio	SR-3A	1°
Luminance		
Chromaticity		
Lum Uniformity		
Response Time	BM-7A	2°

FIG. 2 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for “black” and “white”.

Response Time = Rising Time(Tr) + Falling Time(Tf)

- Rising Time(Tr) : Full White 90% → Full White 10% Transmittance.
- Falling Time(Tf) : Full White 10% → Full White 90% Transmittance.

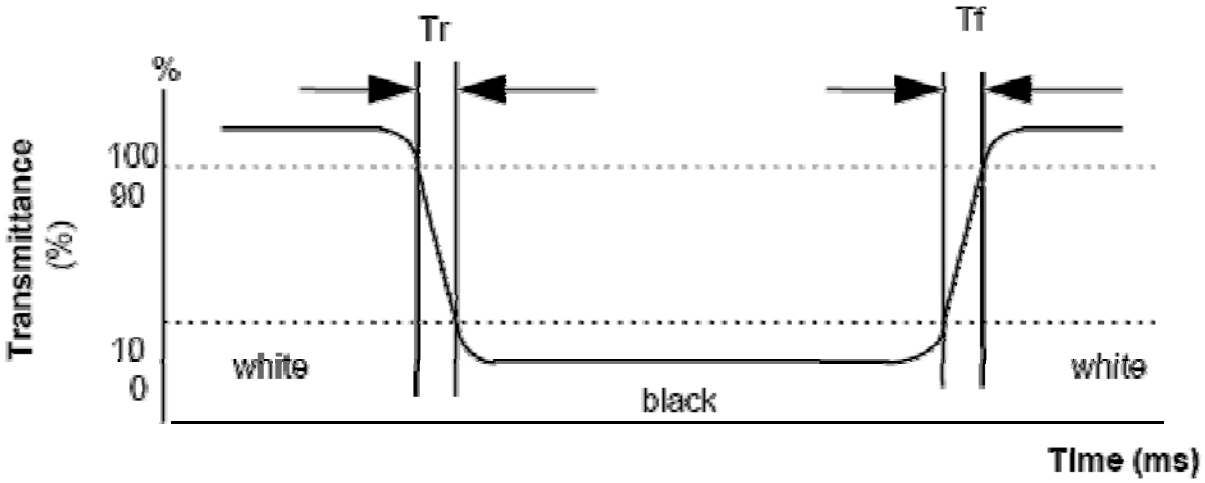
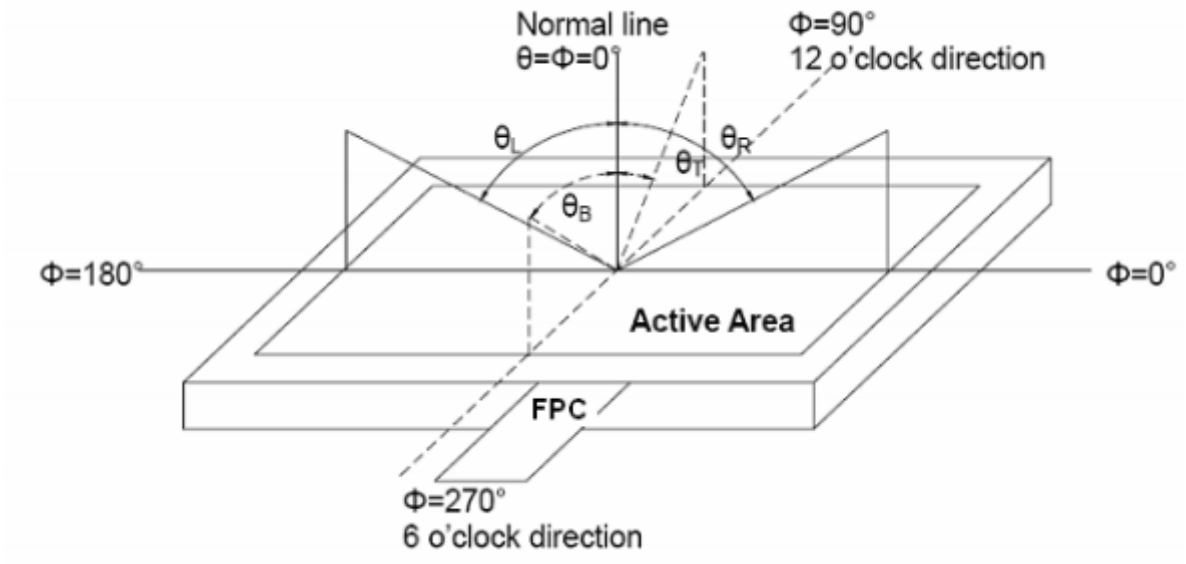
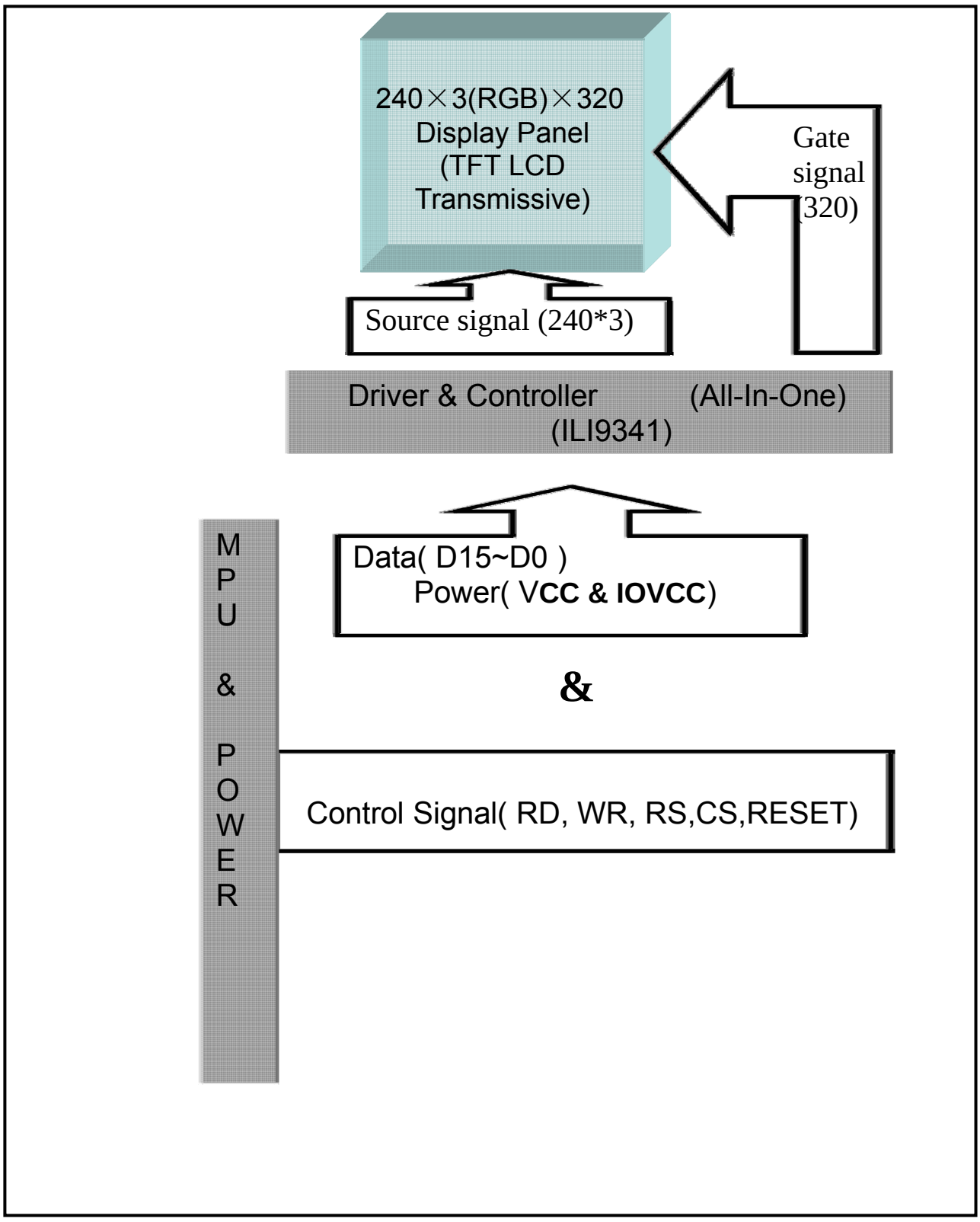


FIG. 3 The definition of Viewing Angle

Use Fig. 1(Test Procedure) under Measurement System to measure the contrast from the measuring direction specified by the conditions as the following figure.



5.Block Diagram



6.Pin Description

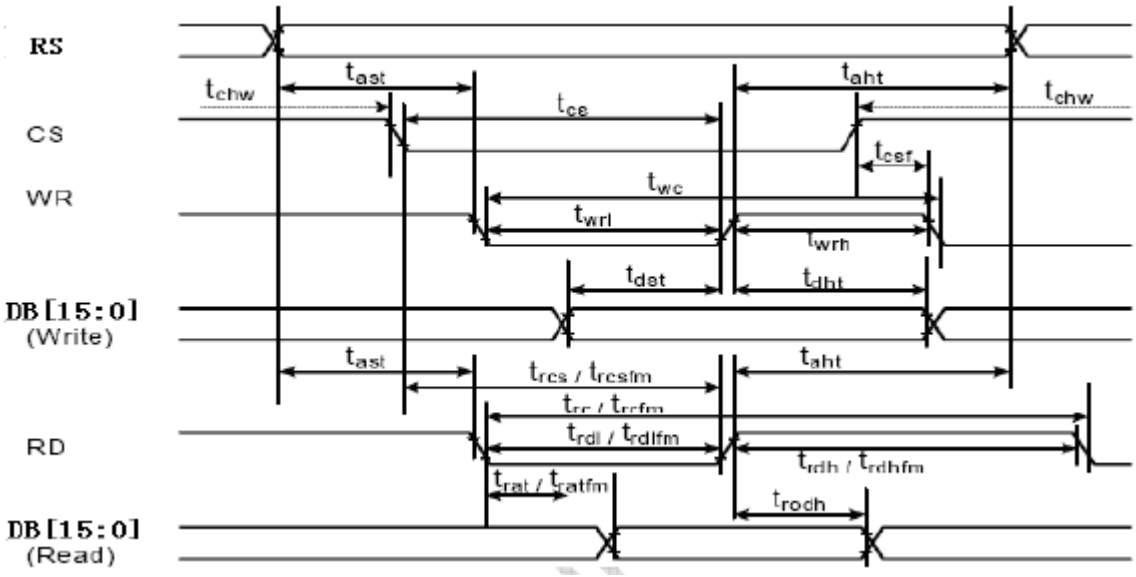
Item	Terminal	Functions
1	GND	POWER GROUND
2	YD	Touch Panel Bottom Side
3	XL	Touch Panel Left Side
4	YU	Touch Panel Up Side
5	XR	Touch Panel Right Side
6	NC	NC
7	VCC	Power Input 2.8V-3.0V
8	IOVCC2	Power Input 1.8V-3.0V
9	FMARK	Frame Rate
10	CS	Chip select signal
11	RS	Register select signal
12	WR	Write enables signal
13	RD	Read enables signal
14-29	D0-D15	Data Input
30	RESET	Reset signal
31	IM0	IM0=1,D8-D5 useful, 8 bits;IM0=0,D0-D15 useful, 16 bits
32	NC	NC
33	GND	Power Ground
34	LED_K1	LED Light Cathode
35	LED_K2	LED Light Cathode
36	LED_K3	LED Light Cathode
37	LED_K4	LED Light Cathode
38	LED_A	LED Light Anode
39	GND	Power Ground
40	NC	NC

Note 1:

IM0	Interface	Data Bus Use	
		Register/Content	GRAM
0	8080 MCU 16_Bit Parallel	DB7~DB0	DB15~DB0
1	8080 MCU 8_Bit Parallel	DB15~DB8	DB15~DB8

7.Timing Characteristics

7.1. Interface Characteristics

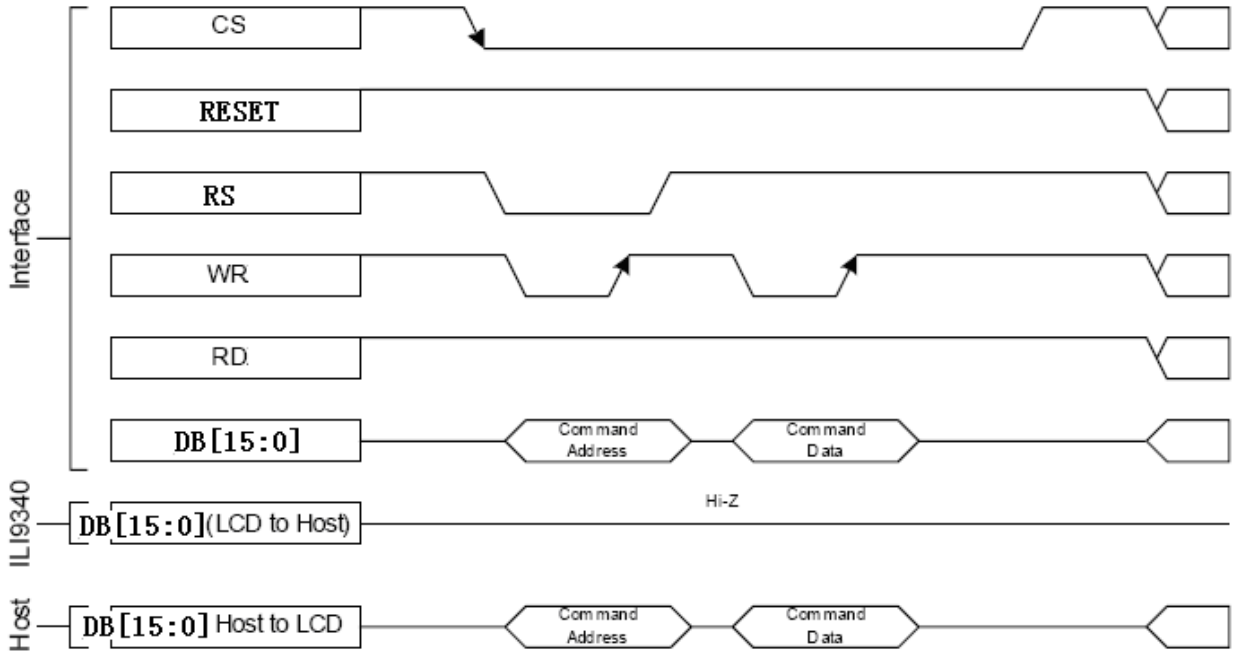


7.2 Timing Parameter

Signal	Symbol	Parameter	min	max	Unit	Description
RS	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	10	-	ns	
CS	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WR	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RD (FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RD (ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
DB[15:0] DB[15:8]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

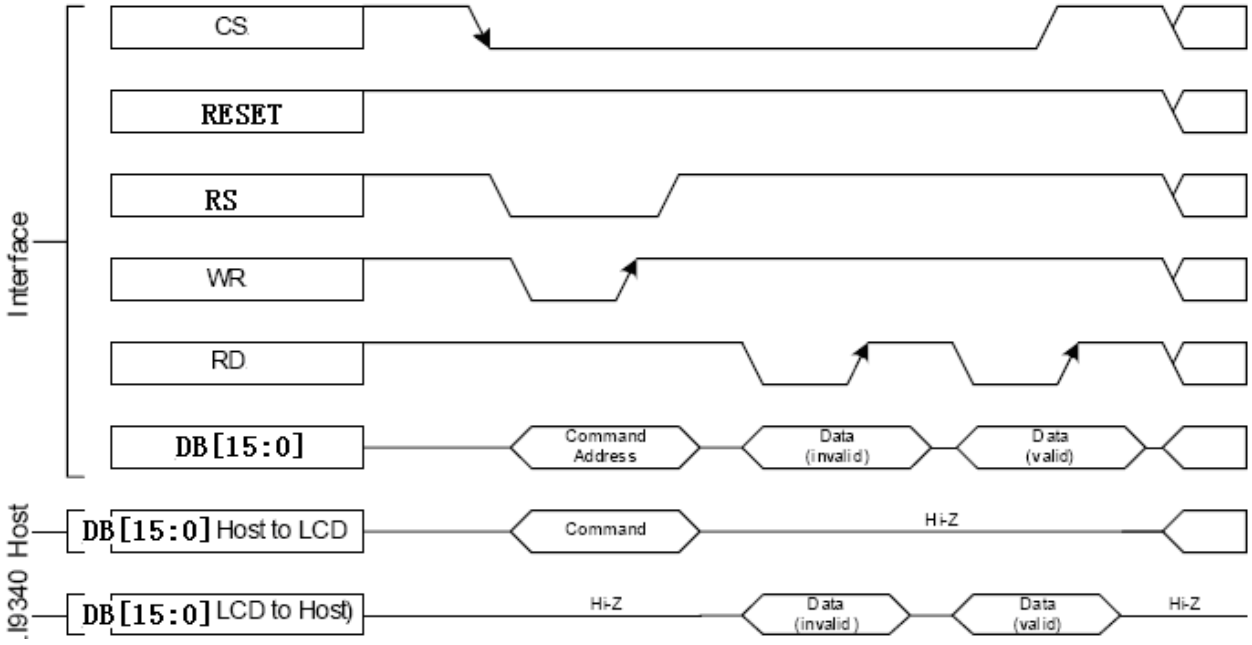
7.3 Register Write/Read Timing Parameter

a. Write to Register



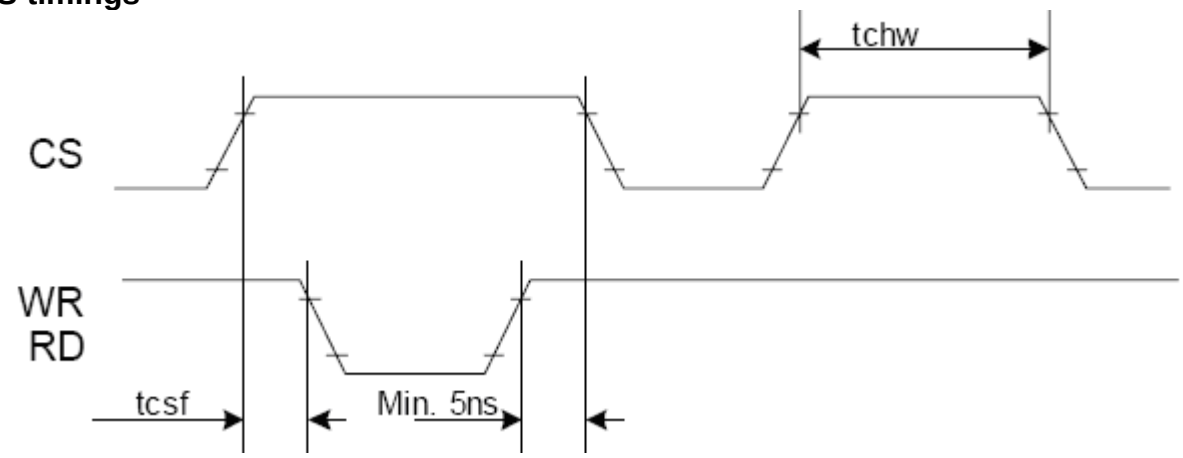
Register write timing in parallel bus system interface

b. Read to Register

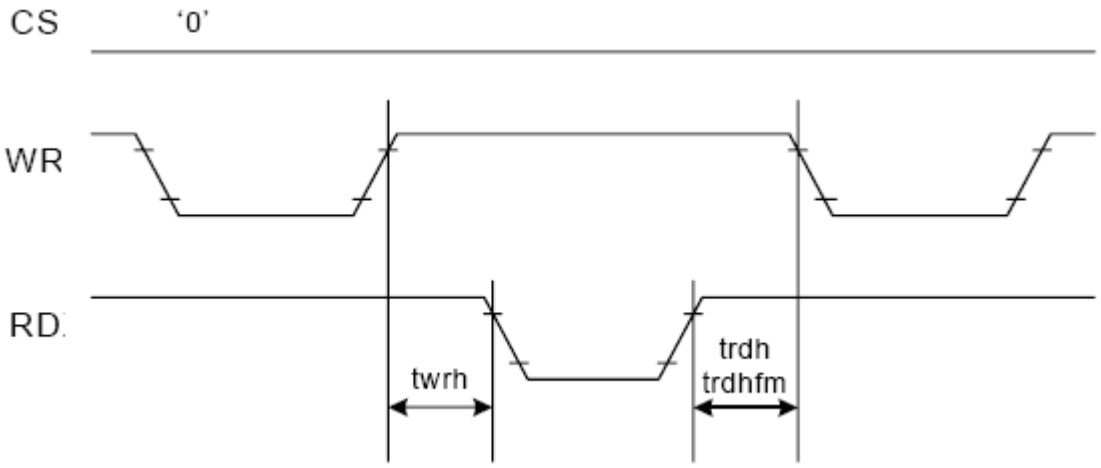


Register read timing in parallel bus system interface

7.4 CS timings

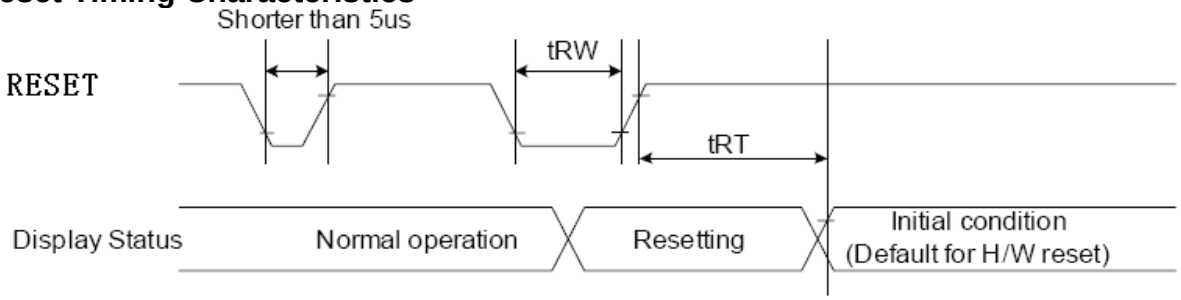


Chip selection timing



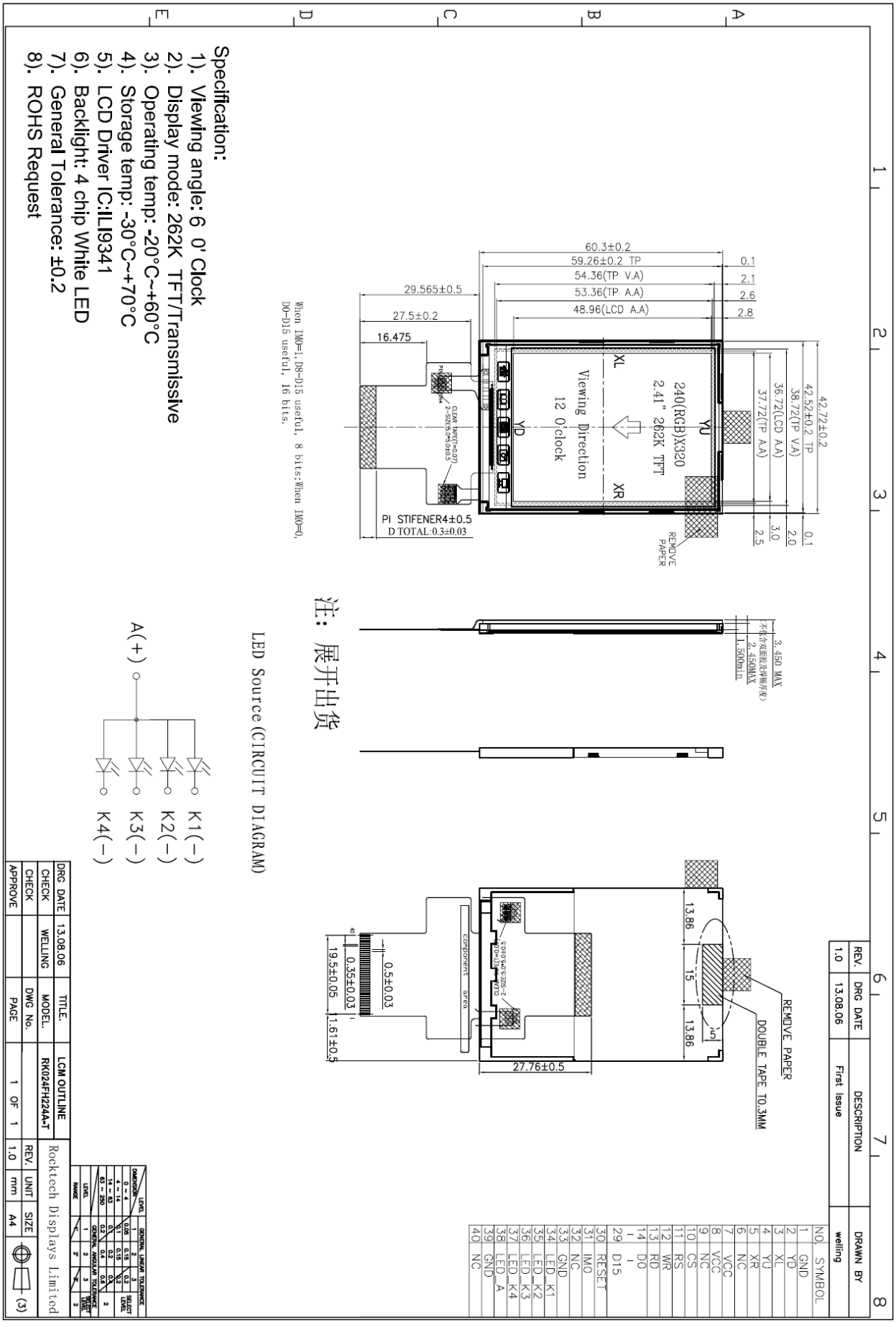
Write-to-read and read-to-write timing

7.5 Reset Timing Characteristics



Signal	Symbol	Parameter	Min	Max	Unit
RESET	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
				120 (note 1,6,7)	mS

8.Outline Dimension



9. Reliability and Inspection Standard

No.	Test Item		Test Conditions	Remark
1	High Temperature	Storage	70℃, 120Hr	Note
		Operation	60℃, 120Hr	Note
2	Low Temperature	Storage	-30℃, 120Hr	Note
		Operation	-20℃, 120Hr	
3	High Temperature and High Humidity		60℃, 90%RH, 240Hr	Note
4	Peeling Off (Storage)		≧500gf/cm	Note
5	FPC Bending Test		≧6,000 times, 2/sec	Note
6	Vibration Test(Storage)		50HZ, 30min, Amplitude: 2 cm, X/Y/Z directions	Note
7	Drop Test		60cm/ 3Corner/ 8Face, 1Cycle	Note

Note:

1) The test samples should be applied to only one test item.
2) Sample size for each test item is 5~10pcs.
3) For Damp Proof Test, pure water(Resistance>1MΩ) should be used.
4) In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
5) EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and fluorescence EL has.
6) After the reliability test, the test samples should be inspected after 2 hours at least.
7) Functional test is OK. Missing segment, shorts, unclear segment, non display, display abnormally, liquid crystal leak are not allowed.
8) After testing, the current Idd should be within initial value ±20%.
9) No low temperature bubbles ,end seal loose and fall, frame rainbow, ACF bubble growing are allowable in the appearance test.

10.PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

(1) The display panel is made of glass and polarizer. As glass is fragile, it tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
- Isopropyl alcohol
- Ethyl alcohol
Do not scrub hard to avoid damaging the display surface.
(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
- Water
- Ketone
- Aromatic solvents
Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.
(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
(9) Do not attempt to disassemble or process the LCD module.
(10) NC terminal should be open. Do not connect anything.
(11) If the logic circuit power is off, do not apply the input signals.
(12) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
- Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal

connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist LCM.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.
(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
- Exposed area of the printed circuit board.
-Terminal electrode sections.